

# KTH7801

***16-bit Programmable non-contact  
Hall magnetic encoders  
with ABZ and PWM outputs***

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# 1 Product Factsheet

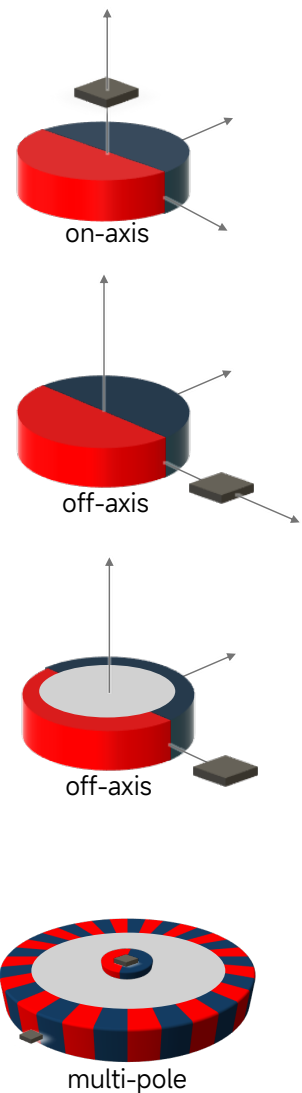
## Features

- 16-bit resolution absolute angle output
- High precision ( $< \pm 0.35^\circ$  accuracy error)
- Suitable for on-axis and off-axis non-contact scenarios
- Ultra-low latency (1  $\mu$ s data updates)
- SPI communication: angle reading, register read / write
- SSI communication: angle reading
- Programmable 4-4096 steps / turn ABZ output
- PWM 14-bit angle output
- AEC-Q100 standard qualified
- Built-in programmable memory (MTP)
- Magnetic field strength diagnosis / alarm
- Operating voltage: 3.0V to 5.5V
- Operating temperature range:  $-40^\circ\text{C}$  to  $125^\circ\text{C}$
- QFN-16L package: 3mm  $\times$  3mm and SOP-8 4.9mm  $\times$  6mm

## Presentation

The KTH7801 is a high-precision absolute angle Hall sensor chip offering up to 16-bit resolution for accurate angle measurements in both on-axis and off-axis configurations. Capable of handling rotational speeds ranging from 0 to 120,000 rpm, the KTH7801 ensures rapid and precise angle output, making it a robust choice for applications requiring accurate angle measurement and speed control.

The KTH7801 provides multiple flexible angle output modes to meet diverse application needs. First, it supports a programmable ABZ quadrature pulse output with up to 4096 steps per revolution, delivering high-resolution position data. Additionally, the 4-wire SPI interface facilitates efficient angle reading and device communication. The KTH7801 also supports a 2-wire SSI output, simplifying system design and integration.



## Typical Applications

- Absolute position sensor
- Brushless DC motor
- Off-axis angle measurement
- Automotive Angle Control
- Closed-Loop Stepper Motor
- Barrier gates

To further enhance its practical application, the KTH7801 features built-in magnetic field strength detection. Users can program high and low magnetic field thresholds, enabling real-time monitoring and adjustment. This functionality helps to select the optimal magnet and determine the appropriate installation setup, ensuring stable operation.

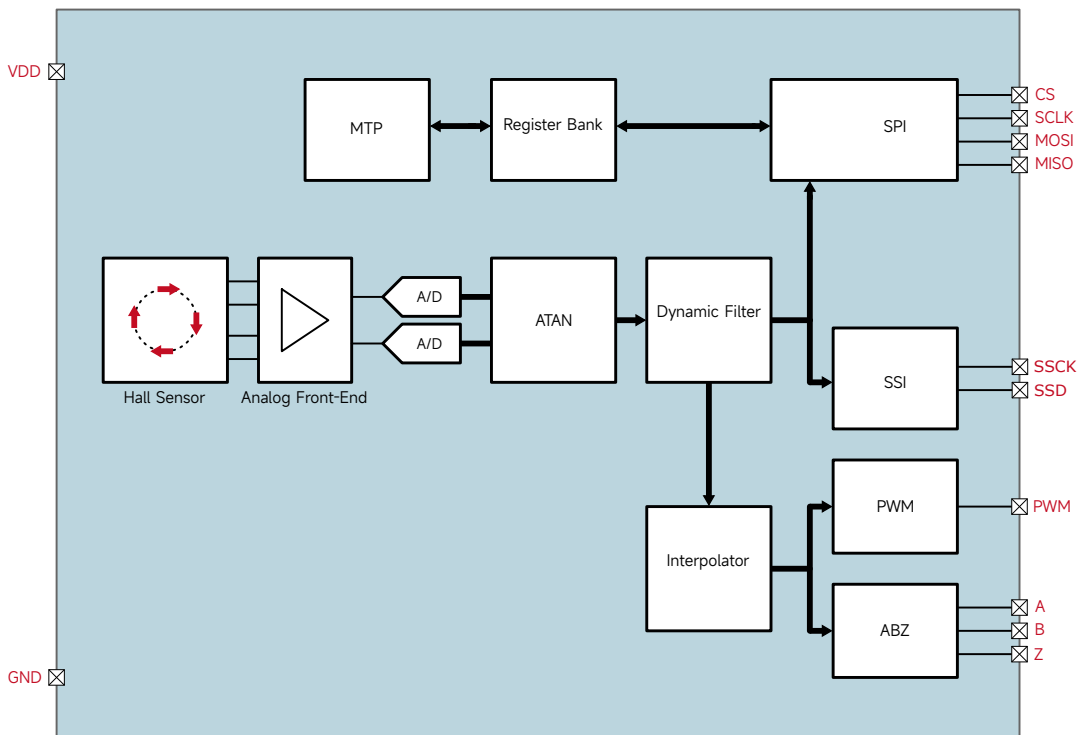
Moreover, the KTH7801 incorporates Memory-Programmable Technology (MPT) to store critical configuration parameters. Users can save settings such as the zero-angle position, ABZ encoder configurations, and magnetic field detection thresholds, allowing for adaptable performance across various operational environments.

In summary, the KTH7801 is engineered to provide versatility, accuracy, and adaptability, making it a reliable solution for a wide range of angle measurement and control applications.

## 2 Overview

### 2.1 System Architecture

Figure 1: Top diagram



The KTH7801 is a Hall angle encoder that integrates Hall elements, analog-to-digital converters (ADC), and various modules for precise angle measurement and digital signal output.

The Hall element in the encoder generates voltage signals, which are converted into two orthogonal digital signals through the ADC. These signals are then processed by the ATAN module to obtain a 16-bit digital angle. The digital angle is further adjusted through zero-point setting, rotation direction setting, and filtering.

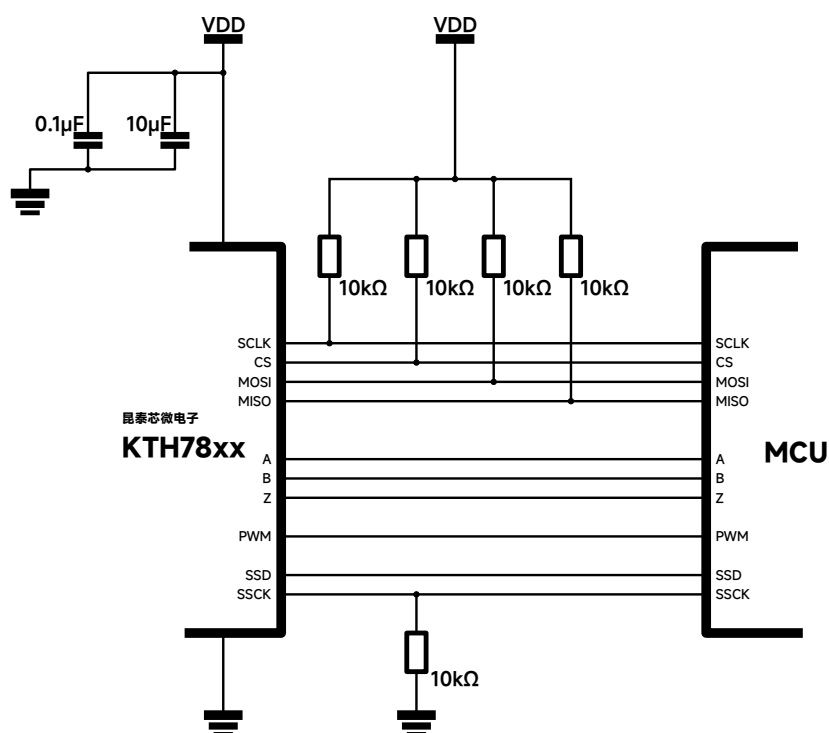
The encoder's output interface can directly provide the filtered angle data through SPI and SSI communication, allowing the user to read it directly using an MCU or other circuits. Additionally, the angle can also be represented through PWM modulation, with the angle value reflected by the duty cycle.

To enhance the update rate, the filtered angle can be further processed by an interpolator and output to the ABZ angle encoder module, converting the angle into the desired encoded signal.

Moreover, various operating parameters of the system are stored in a multi-time programmable (MTP) memory, which can be modified through SPI commands to meet different application requirements.

## 2.2 Recommended Application Circuit

Figure 2: Recommended Application Circuit



Note: The pull-up and pull-down resistors shown in the diagram can be optionally added or removed by the user. For automotive applications, it is recommended to add a TVS diode to the power supply to protect the circuit from transient high-voltage spikes.

2.3 Pin Definitions

Figure 3: QFN-16L 3mmx3mm

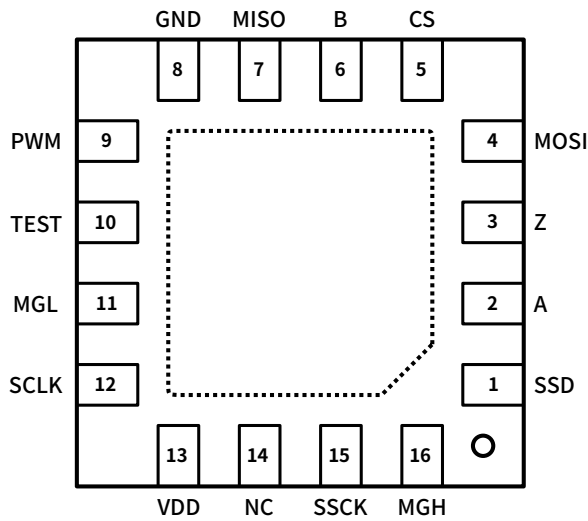


Table 1: Pin Functions

| N. | Name | Function  |
|----|------|---|
| 1  | SSD  | SSI Data Output                                     |
| 2  | A    | One of the ABZ incremental output signals           |
| 3  | Z    | One of the ABZ incremental output signals           |
| 4  | MOSI | SPI Master Data Output (pull-up to VDD if not used) |
| 5  | CS   | SPI Chip Select (pull-up to VDD if not used)        |
| 6  | B    | One of the ABZ incremental coding signals           |
| 7  | MISO | SPI Slave Data Output                               |
| 8  | GND  | Ground  |
| 9  | PWM  | Pulse Width Modulation                              |
| 10 | TEST | Factory Testing (pull-down to GND)                  |
| 11 | MGL  | Low Magnetic Field Strength                         |
| 12 | SCLK | SPI Clock (pull-up to VDD if not used)              |
| 13 | VDD  | Power Supply Input                                  |
| 14 | NC   | Not Connected                                       |
| 15 | SSCK | SSI Data Clock Input (pull-down to GND if not used) |
| 16 | MGH  | High Magnetic Field Strength                        |



Figure 4: SOP-8 4.9mmx6mm

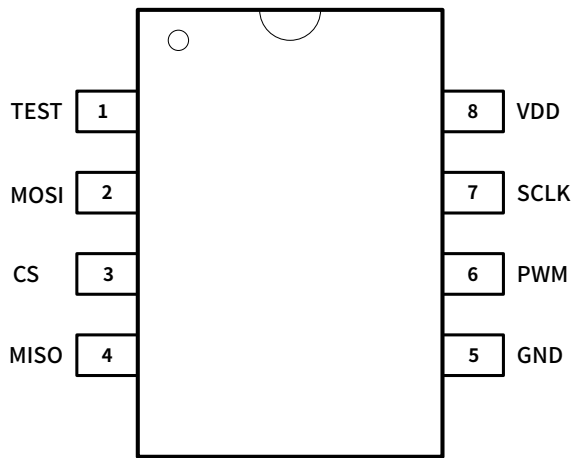


Table 2: Pin Functions

| Num | Name | Function  |
|-----|------|---|
| 1   | TEST | TEST pin floating during operation                  |
| 2   | MOSI | SPI Master Data Output (pull-up to VDD if not used) |
| 3   | CS   | SPI Chip Select (pull-up to VDD if not used)        |
| 4   | MISO | SPI Slave Data Output                               |
| 5   | GND  | Ground  |
| 6   | PWM  | Pulse Width Modulation                              |
| 7   | SCLK | SPI Clock (pull-up to VDD if not used)              |
| 8   | VDD  | Power Supply Input                                  |

For the KTH7801 product utilizing a QFN-16L 3x3mm package, it is mandatory to directly connect the TEST pin to the Ground (GND).

Conversely, for the KTH7801 product with a SOP-8 4.9mm×6mm package, the TEST pin should be left floating during operation.

The KTH7801 product is available in two package formats: QFN-16L and SOP-8, with pin definitions as described above. Due to the reduced pin count in the SOP-8 package, the number of output signals is correspondingly reduced.

The KTH7801 offers a wide range of pin functionalities, including ABZ-encoded incremental output, Pulse Width Modulation (PWM) output, as well as SSI and SPI communication capabilities.

## 2.4 16-bit Binary Encoding of Angles

The KTH7801 encoder represents angle values using a 16-bit binary encoding scheme. By converting angle values into a 16-bit binary form, precise representation of angles can be achieved. For instance, angle values can be expressed as integers in binary form, ranging from 0 to 65535. In general, the angles discussed in this document are represented using 16-bit binary encoding.

The relationship between the 16-bit binary value and the corresponding angle output (ranging from 0° to 360°) can be expressed mathematically as:

$$\text{Angle Output (0° to 360°)} = \frac{\text{16-bit binary value}}{2^{16}} \times 360 \quad (1)$$

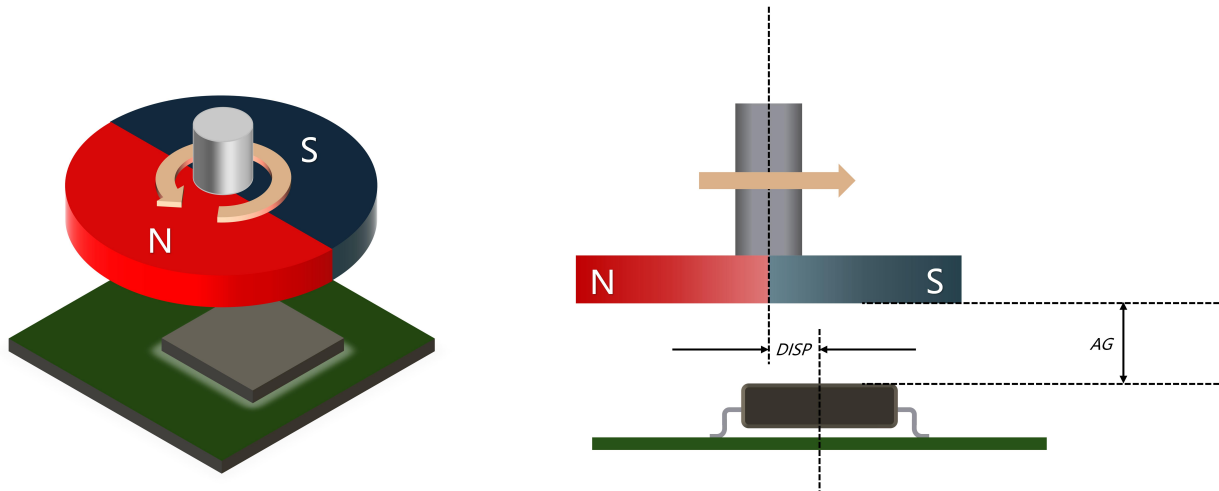
Equation 1 demonstrates how the 16-bit binary value can be converted to its corresponding angle output. The division by  $2^{16}$  normalizes the binary value to a range between 0 and 1, which is then multiplied by 360 to obtain the angle output in degrees. This encoding scheme allows for accurate representation and measurement of angles using the KTH7801 encoder.

## 2.5 On-Axis Magnet Installation Recommendation

**Table 3: On-Axis Magnet Installation Recommendation**

| Para.              | Description                             | Min | Typ.   | Max | Unit |
|--------------------|---|-----|--------|-----|------|
| $D_{\text{mag}}$   | Radial Magnet Diameter                  |     | 10     | 30  | mm   |
| $T_{\text{mag}}$   | Recommended Magnet Thickness            |     | 2.5    | 5   | mm   |
| $B_{\text{pk}}$    | Chip Operating Magnetic Field           | 30  |        | 150 | mT   |
| $AG$               | Air Gap                                 |     | 1.0    | 5.0 | mm   |
| $RS$               | Rotational Speed                        |     |        | 120 | krpm |
| $DISP$             | Installation Deviation                  |     | 0.3    | 1.0 | mm   |
| $TC_{\text{mag1}}$ | Temperature Coefficient of NdFeB Magnet |     | -0.120 |     | %/°C |
| $TC_{\text{mag2}}$ | Temperature Coefficient of SmCo Magnet  |     | -0.035 |     | %/°C |

**Note: It is recommended to use NdFeB or SmCo magnets.**

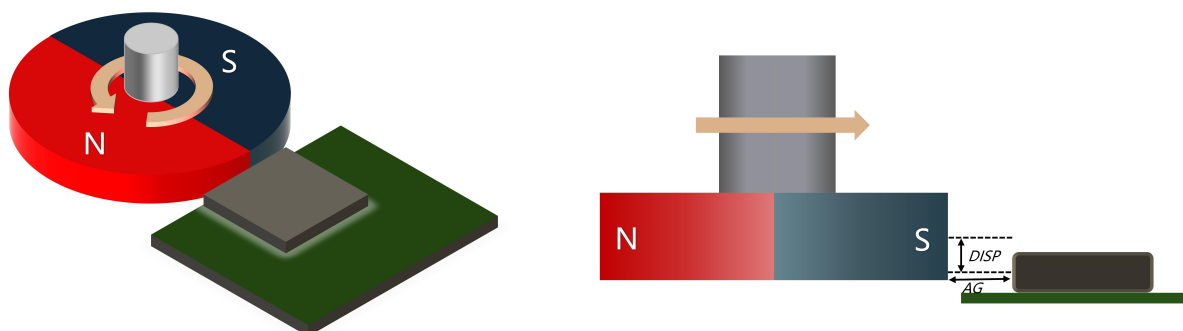
**Figure 5: On-Axis Magnet Chip Placement**

## 2.6 Off-Axis Magnet Installation Recommendation

**Table 4: Off-Axis Magnet Installation Recommendation**

| Para.            | Description                             | Min | Typ. | Max | Unit |
|------------------|---|-----|------|-----|------|
| $D_{\text{mag}}$ | Radial Magnet or Magnetic Ring Diameter |     | 10   | 30  | mm   |
| $T_{\text{mag}}$ | Recommended Magnet Thickness            |     | 2.5  | 5   | mm   |
| $B_{\text{pk}}$  | Chip Operating Magnetic Field           | 30  |      | 150 | mT   |
| $AG$             | Air Gap                                 |     | 0.5  | 5   | mm   |
| $RS$             | Rotational Speed                        |     |      | 120 | krpm |
| $DISP$           | Installation Deviation                  |     | 0.5  | 2   | mm   |

Note: It is recommended to use NdFeB or SmCo magnets.

**Figure 6: Off-Axis Magnet Chip Placement**

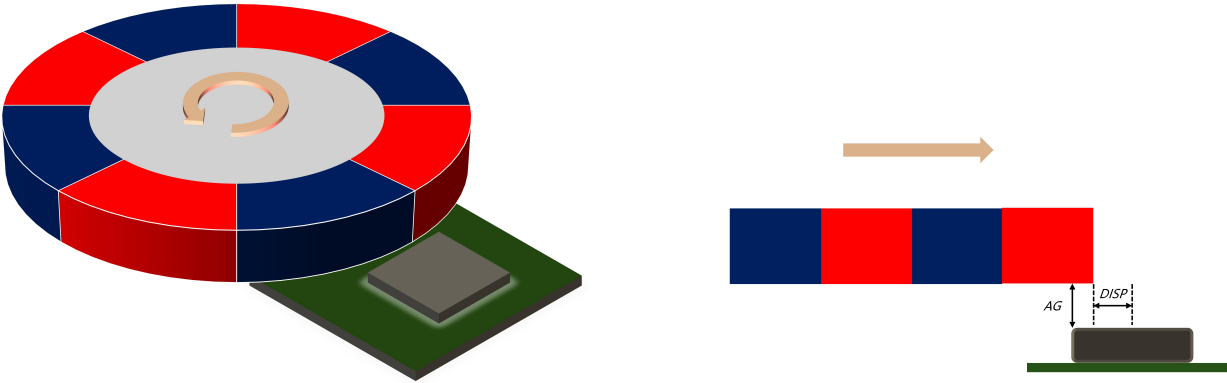
## 2.7 Multi-Pole Magnet Installation Recommendation

**Table 5: Multi-Pole Magnet Installation Recommendation**

| Para.            | Description                                      | Min | Typ. | Max | Unit |
|------------------|--|-----|------|-----|------|
| $W_{\text{mag}}$ | Multi-Pole Magnet Pole Width (Single Pole Width) | 2   |      | 10  | mm   |
| $T_{\text{mag}}$ | Recommended Magnet Thickness                     |     | 2    | 5   | mm   |
| $B_{\text{pk}}$  | Chip Operating Magnetic Field                    | 30  |      | 150 | mT   |
| $AG$             | Air Gap  |     | 0.5  | 3   | mm   |
| $RS$             | Rotational Speed                                 |     |      | 120 | krpm |
| $DISP$           | Distance Between Chip Center and Magnet Edge     | 0.8 | 1.0  | 5.0 | mm   |

Note: It is recommended to use NdFeB or SmCo magnets. In multi-pole applications, there is no restriction on the magnetic ring diameter. Due to the complexity, it is advisable to consult our FAE team for magnetic field simulation to find the optimal placement.

Figure 7: Multi-Pole Magnet Chip Placement



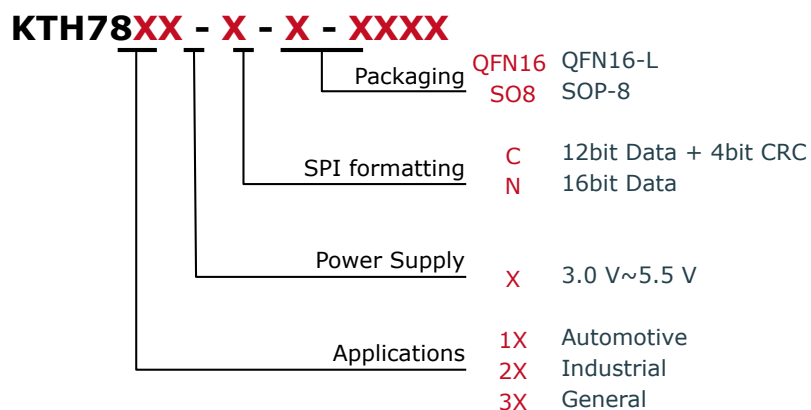
2.8 Register Configuration

|      |               |         |   |          |   |   |       |       |
|------|---------------|---------|---|----------|---|---|-------|-------|
| 0x00 | Z(7:0)        |         |   |          |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x01 | Z(15:8)       |         |   |          |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x02 | GAINtrim(7:0) |         |   |          |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x03 |               |         |   |          |   |   | Ytrim | Xtrim |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x04 | PPT(1:0)      | ZL(1:0) |   | ZD(1:0)  |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x05 | PPT(9:2)      |         |   |          |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x06 | mgh(2:0)      |         |   | mgl(2:0) |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x07 | NPP(2:0)      |         |   |          |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
| 0x09 | RD            |         |   |          |   |   |       |       |
|      | 7             | 6       | 5 | 4        | 3 | 2 | 1     | 0     |
|      | MSB           |         |   |          |   |   |       | LSB   |

**Table 6: Parameter Description**

| Symbol        | Default Value (Decimal) | Name   | Description                              |
|---------------|-------------------------|--|--|
| GAINtrim(7:0) | 2                       | Sensitivity Modulation Coefficient                           |  |
| Xtrim         | 0                       | Reduce X-Axis Hall Sensitivity                               |  |
| Ytrim         | 1                       | Reduce Y-Axis Hall Sensitivity                               |  |
| mgh(2:0)      | 7                       | Magnetic Field High Alarm Threshold, Default Max Value Alarm | Section 9.3 Threshold Detection Settings |
| mgl(2:0)      | 0                       | Magnetic Field Low Alarm Threshold, Default Min Value Alarm  | Section 9.3 Threshold Detection Settings |
| PPT(9:0)      | 1023                    | ABZ Resolution, Default 1024 Lines, 4096 Steps/Turn          | Section 7.1 ABZ Output Resolution        |
| RD            | 1                       | Rotation Direction Setting, Default Forward Rotation as 1    | Section 9.3 Threshold Detection Settings |
| Z(15:0)       | 0                       | Zero Position Setting, Default is 0                          | Section 9.2 Zero Point Setting           |
| ZL(1:0)       | 0                       | Z Signal Width of ABZ, Default is 0                          | Section 7.2 Zero Index Signal Z          |
| ZD(1:0)       | 0                       | Z Signal Phase of ABZ, Default is 0                          | Section 7.2 Zero Index Signal Z          |

### 3 Product model number composition



### 4 Key Parameters

**Table 7: Key Specifications @3.3V Supply**

| Parameter               | Minimum | Typical     | Maximum   |
|-------------------------|---------|-------------|-----------|
| Operating Voltage       | 3.0V    | 3.3V        | 3.6V      |
| Magnetic Field Strength | 30mT    | 60mT        | 150mT     |
| Operating Current       |         | 11.6mA      |           |
| Start-up Time           |         | 1ms         |           |
| Latency Time            |         | 1us         |           |
| Output Noise (1 sigma)  |         | 0.015°      |           |
| Temperature Drift       |         | 0.002° / °C |           |
| Nonlinearity Error      |         | ±0.35°      |           |
| Rotational Speed        |         |             | 120000rpm |
| ESD (HBM)               |         | ±5KV        |           |

**Table 8: Key Specifications @5V Supply**

| Parameter               | Minimum | Typical     | Maximum   |
|-------------------------|---------|-------------|-----------|
| Operating Voltage       | 4.5V    | 5V          | 5.5V      |
| Magnetic Field Strength | 30mT    | 60mT        | 150mT     |
| Operating Current       |         | 13.6mA      |           |
| Start-up Time           |         | 1ms         |           |
| Latency Time            |         | 1us         |           |
| Output Noise (1 sigma)  |         | 0.015°      |           |
| Temperature Drift       |         | 0.002° / °C |           |
| Nonlinearity Error      |         | ±0.35°      |           |
| Rotational Speed        |         |             | 120000rpm |
| ESD (HBM)               |         | ±5KV        |           |



## 5 SPI

The KTH7801 product uses an SPI interface to achieve reliable and efficient data communication between the microcontroller and peripherals. The SPI communication operates in mode 3 (CPOL = 1 and CPHA = 1), supporting functions such as reading the angle, reading configuration registers, and writing to configuration registers.

### 5.1 SPI timing

**Figure 8: SPI Timing Diagram**

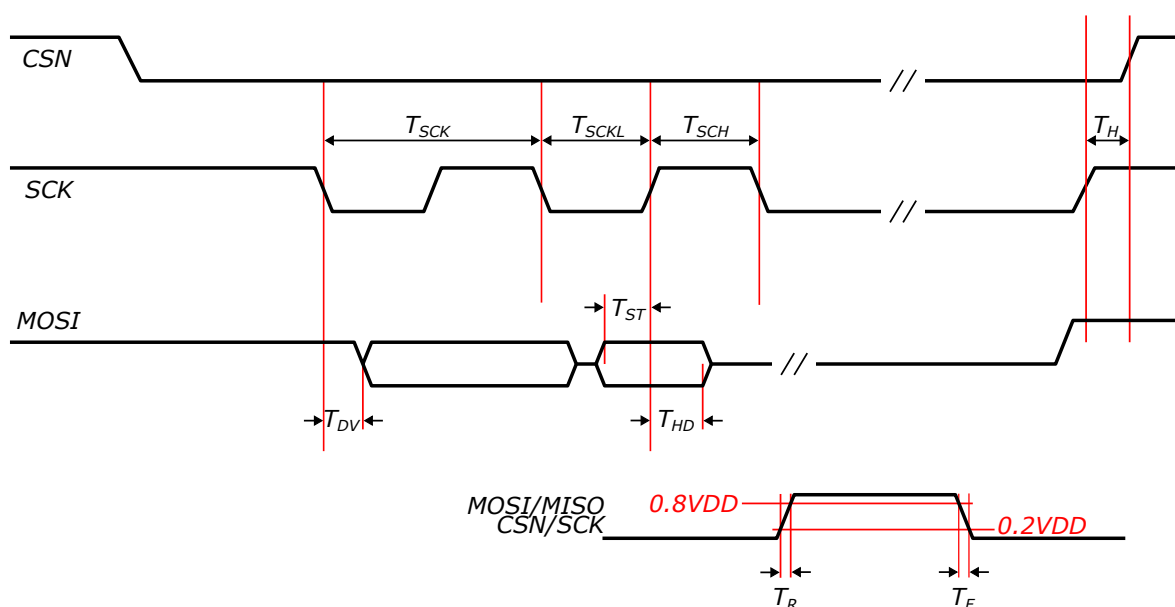


Figure 8 presents an SPI timing diagram, while Table 9 provides detailed information on the SPI timing parameters of the KTH7801 product under a 20pF load condition. This table includes symbols, descriptions, and the minimum, typical, and maximum values for each parameter, expressed in nanoseconds (ns). These parameters play a crucial role in defining the timing requirements for SPI communication, ensuring dependable data transfer between microcontrollers and peripheral devices when utilizing the KTH7801 product.

**Table 9: SPI Timing Parameters (with 20pF Load Condition)**

| <b>Symbol</b> | <b>Description</b>                                | <b>Min.<br/>Value</b> | <b>Typical<br/>Value</b> | <b>Max.<br/>Value</b> | <b>Unit</b> |
|---------------|---|-----------------------|--------------------------|-----------------------|-------------|
| $T_{SCK}$     | SCK Clock Period                                  | 100                   |                          |                       | ns          |
| $T_{SCKL}$    | Low Period of SCK Clock                           | 50                    |                          |                       | ns          |
| $T_{SCKH}$    | High Period of SCK Clock                          | 50                    |                          |                       | ns          |
| $T_H$         | Time interval between<br>SCK and CSN rising edges | 120                   |                          |                       | ns          |
| $T_R$         | Rise Time of Digital signal                       |                       | 10                       |                       | ns          |
| $T_F$         | Fall Time of Digital signal                       |                       | 10                       |                       | ns          |
| $T_{DV}$      | Data Valid Time of MISO                           |                       |                          | 50                    | ns          |
| $T_{ST}$      | Setup Time of MOSI Data                           | 50                    |                          |                       | ns          |
| $T_{HD}$      | Hold time of MOSI Data                            | 50                    |                          |                       | ns          |

The KTH7801 product employs the SPI interface, operating in CPOL = 1 and CPHA = 1 mode, to facilitate communication between microcontrollers and peripheral devices. Conforming to the SPI international standard, the interface incorporates four lines: SCK, MOSI, MISO, and CSN. Data transmission occurs through fixed-length 16-bit packets.

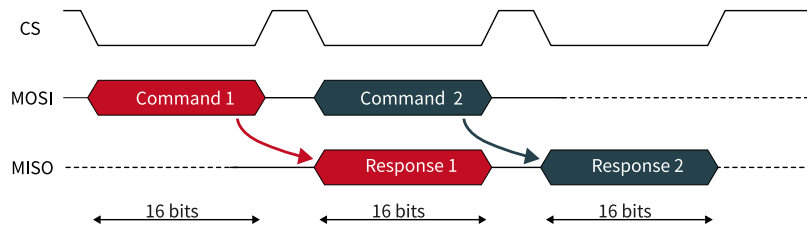
The SPI timing parameter table serves as a valuable resource for comprehending the correct utilization and debugging of hardware and firmware designs pertaining to the SPI interface. Adhering to these timing parameters is critical to ensuring reliable data communication through meticulous hardware and firmware design.

All aforementioned SPI parameters are implemented in the provided hardware and firmware, allowing users to configure and optimize them based on their specific application requirements. Our technical support team is readily available to assist users with any challenges encountered during usage.

In summary, the SPI interface of the KTH7801 product is a robust and versatile communication tool, suitable for a wide range of microcontrollers and peripheral devices. By comprehending and effectively employing these SPI timing parameters, users can maximize the product's performance and fulfill their spe-

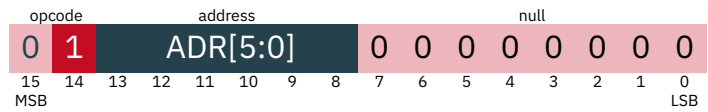
cific application needs.

**Figure 9: SPI Command-Response Overlapped Structure**



SPI communication adopts an overlapped structure that allows the transmission of a response from the previous command while sending the next command. Figure 9 illustrates an example of a single-device setup, where the host controls a KTH7801 slave device.

## 5.2 Reading Registers via SPI



The operation of reading registers involves two 16-bit frames.

The first frame is the write request frame, comprising a 2-bit write command, a 6-bit register address, and 8 bits of zero padding. The second frame is the returned register value, formatted as XXXX – XXXX – 0000 – 0000.

The table above presents the instruction format for this operation. Starting from the most significant bit (MSB), the first 2 bits represent the opcode, the operation code of the instruction. The subsequent 6 bits denote the address, specifying the register’s location. The remaining blank section represents invalid bits, padded with zeros.

## 5.3 Register Writing via SPI



The KTH7801 chip provides the capability to write to registers via the SPI bus. Registers are programmable 8-bit storage units used to store specific configuration and control parameters, allowing customization of the chip’s behavior and functionality.

The process of writing to registers via SPI involves two 16-bit frames. The first frame is the write request frame, consisting of a 2-bit write command (10), followed by a 6-bit register address and an 8-bit value. The write command instructs the chip to perform the write operation, the register address specifies which register to write to, and the value represents the data to be written. Data transmission starts from the Most Significant Bit (MSB).

The second frame is the returned acknowledgment frame, containing the value of the newly written register. The frame format is XXXX – XXXX – 0000 – 0000. This acknowledgment

frame serves as a response from the chip, confirming the successful writing of data into the register.

During the process of writing to registers via SPI, it is important to note that a minimum wait time of 20 milliseconds between the first frame and the second frame is required. This wait time ensures that the written data is correctly stored in the chip's non-volatile memory. Failing to wait for an adequate amount of time after the write request may result in reading the previous value of the register. Therefore, it is crucial to adhere to this wait time when performing register writing operations.

It is worth mentioning that this wait time is applicable only to write operations. For read register or read angle operations, no wait time is required.

The register values of the KTH7801 chip are automatically loaded during power-up as they are stored in the chip's non-volatile memory. This means that even after a power loss and subsequent power-up, the configuration and control parameters stored in the registers will remain unchanged without the need for reconfiguration.

To ensure long-term stability and reliability of the registers, the memory design of the KTH7801 chip is carefully engineered to withstand 1,000 write cycles and maintain reliable operation even in environments with a temperature of up to 125°C.

By utilizing register writing via SPI, you can easily configure and fine-tune various functionalities and behaviors of the KTH7801 chip to meet your specific requirements.

## 5.4 Read Absolute Angle via SPI



When using SPI for reading the absolute angle from the KTH7801 angle sensor, the following general steps and principles are involved:

- (1) Set Communication Parameters: First, ensure that the SPI communication parameters between the master device and the KTH7801 angle sensor are configured consistently.

This includes parameters such as clock frequency, data width, and other relevant settings.

- (2) **Trigger Read Operation:** The master device initiates the read operation by pulling the chip select (CS) signal low and sending the appropriate read position command via MOSI. Pulling the chip select signal low signals the sensor to prepare for data transmission to the output buffer.
- (3) **Data Transmission and Reception Process:** Every microsecond, a new data bit is transmitted to the output buffer. The sensor sends the data bit to the master device serially through the MISO pin. The master device controls the data reception by utilizing the clock signal, ensuring the accurate reception of each data bit.
- (4) **Angle Value Interpretation:** Once the master device sends a sufficient number of clock counts, the KTH7801 sensor responds and provides angle data. By interpreting the received data, the corresponding absolute angle value can be obtained.

During the transmission process, it is recommended to keep the MOSI line at a low logic level to prevent interference signals such as 01, 10, and others, which could interrupt the transmission of angle data. This precautionary measure helps to ensure the stability and accuracy of the transmission.

To optimize the angle reading process and ensure that no information is lost, it is possible to reduce the number of clock counts. When a data output length of 12 bits is required, only 12 clock counts are needed to obtain the complete sensor resolution.

If a lower resolution is desired, the angle value can be read by sending fewer clock counts as the most significant bit is transmitted first. This method is known as the fast read mode, where the KTH7801 sensor continuously sends the same data until the data is refreshed. The fast read mode can improve the reading speed.

For a clearer understanding, the following diagram illustrates the process of reading the absolute angle via SPI:



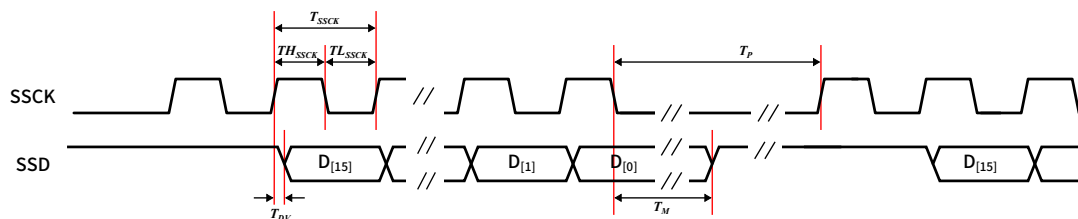
If you choose the version of the chip with SPI output and CRC check, by sending the read position command mentioned in the previous section, you can receive SPI output information with a CRC check on the MISO pin. The output frame format is shown above, where the first 12 bits are position data (MSB first), followed by a 4-bit CRC check word. The CRC check follows the CRC-4/ITU standard with a polynomial of  $X^4 + X + 1$ , an initial value of 00, a final XOR value of 00, input reflected (true), and output reflected (true). For example, if the position data is 0FF and the CRC check value is 2, the received data would be 0FF2. If you need assistance with CRC check code implementation, please contact our FAE team.



## 6 Angle Reading via SSI

SSI (Synchronous Serial Interface) is a synchronous serial interface protocol used for data transfer between digital systems.

**Figure 11: SSI Interface Timing Diagram**



**Table 10: SSI Interface Timing Parameters**

| Symbol      | Description               | Typical Value | Maximum Value | Unit    |
|-------------|---------------------------|---------------|---------------|---------|
| $t_{DV}$    | SSD Data Valid Time       |               | 15            | ns      |
| $T_{DV}$    | SSCK Clock Period         | 0.66          | 16            | $\mu$ s |
| $TL_{SSCK}$ | Low Period of SSCK Clock  | 0.33          | 8             | $\mu$ s |
| $TH_{SSCK}$ | High Period of SSCK Clock | 0.33          | 8             | $\mu$ s |
| $T_M$       | SSD Monoflop Time         | 33            |               | $\mu$ s |
| $T_P$       | Pause Time                | 53            |               | $\mu$ s |

Table 10 shows the timing specifications for the SSI interface.

$T_M$  represents the Monoflop Time, also known as the timeout period. It sets a time limit during data transfer to determine the maximum duration of the data transfer. If the data transfer is not completed or does not reach the next state within the specified  $T_M$  time, it will be considered a timeout. A timeout may indicate a transfer error or other issues that require appropriate error handling. By properly setting  $T_M$ , timely detection and handling of transfer anomalies can be ensured, thereby improving the reliability and stability of the system.

$T_P$  represents the Pause Time, which is the interval during which the system waits after the completion of data transfer before entering the next state. The Pause Time is used to stabilize data transfer, wait for device readiness, or perform other necessary

operations. During  $T_P$ , the system can perform necessary verification, processing, or preparation work to ensure smooth progress of the next round of transfer. By properly setting  $T_P$ , efficient utilization of system resources and good transfer performance can be achieved.

When reading the angle via SSI with the KTH7801, the data bits are transmitted in a high-order priority. Every microsecond, a new data bit is transferred to the output buffer. The read operation is triggered by raising the SSCK signal. A complete read requires a maximum of 17 clock cycles. The first clock cycle is a virtual clock used to initiate the transfer. The most significant bit of the data is transmitted in the second clock cycle. If the data length is less than 16 bits, the output data is extended to a full 16 bits by padding with zeros. Therefore, angle reading can be done in less than 16 clock cycles. When a trigger event is detected, the data will be held in the output buffer until the falling edge of the LSB bit 0 and the monoflop time have passed.

The KTH7801 operates as a slave device to an external SSI master and supports only angle reading operations. It is not possible to read or write registers via the SSI interface.

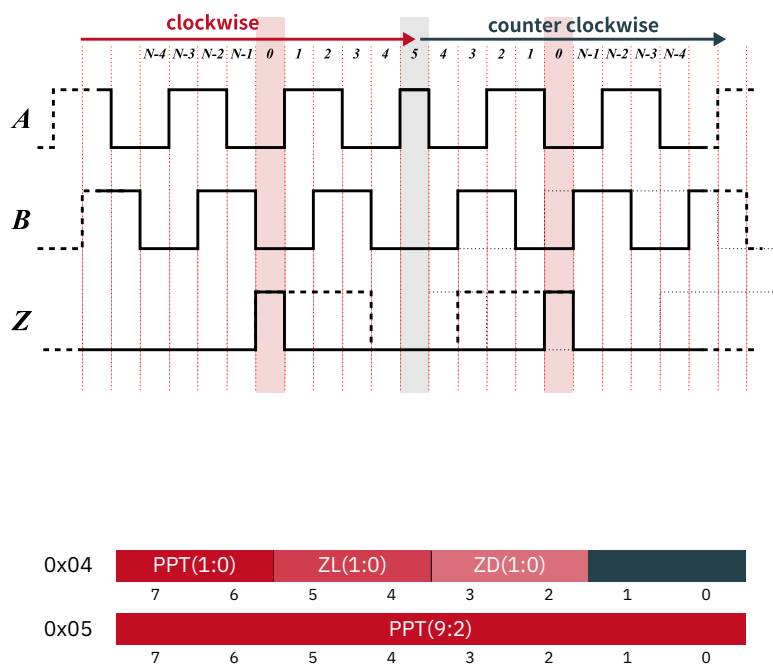
# 7 ABZ Output

The KTH7801 provides angle position output through the incremental interface ABZ. The ABZ interface is configured with a resolution of 12 bits, which means there are 4096 steps per revolution or 1024 pulse periods per revolution (PPT) for the AB signals.

The phase difference between the A and B signals can indicate the direction of rotation. In the clockwise direction, the A signal leads and the B signal follows, while in the counterclockwise direction, the B signal leads and the A signal follows. During power-up, all three ABZ signals will be held at a high level.

When the magnet located directly above the chip (from a top view perspective) rotates counterclockwise (CCW), the rising edge of the B signal will lead the rising edge of the A signal by 1/4 of a period. Conversely, when rotating clockwise (CW), the rising edge of the A signal will lead the rising edge of the B signal by 1/4 of a period. The phase difference between the A and B signals changes with the direction of rotation of the magnet.

Figure 12: ABZ Output Timing



## 7.1 ABZ Output Resolution

The KTH7801's ABZ incremental output can provide angle position output with a customizable integer resolution of up to 1024 pulse periods per revolution (PPT). The resolution can be defined by programming the MTP bits **PPT(9:0)** within the chip. Refer to Table 11 for the corresponding resolutions in pulses per revolution and steps per revolution.

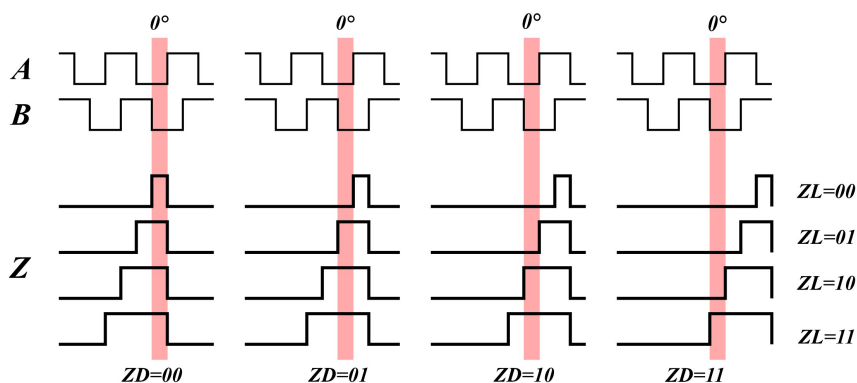
**Table 11: ABZ Resolution for PPT**

| PPT(9:0) | ABZ                       | ABZ                      |
|----------|---------------------------|--------------------------|
|          | Resolution<br>Pulses/Turn | Resolution<br>Steps/Turn |
| 0        | 1                         | 4                        |
| 1        | 2                         | 8                        |
| 2        | 3                         | 12                       |
| ...      | ...                       | ...                      |
| 1021     | 1022                      | 4088                     |
| 1022     | 1023                      | 4092                     |
| 1023     | 1024                      | 4096                     |

## 7.2 Zero Index Signal Z

The Z signal (also known as the index signal or zero reference signal) has a rising edge that occurs once per revolution at the zero position. The position and width of the Z signal can be programmed using the **ZL(1:0)** and **ZD(1:0)** bits in register 0x4. By default, both ZL and ZD parameters are set to 00.

**Figure 13: Width (ZL) and Position (ZD) of the Z Signal in ABZ**



### **7.3 ABZ Hysteresis**

ABZ incremental output hysteresis refers to the introduction of a lag effect on the ABZ output signals to prevent false transitions and improve the system's immunity to interference. Hysteresis means that the output signal must exceed a specific threshold before changing its state. This lag effect helps reduce the impact of noise and other interferences on the output signal. When the input signal changes, the output signal does not immediately follow the change but requires surpassing a threshold to change its state. Setting this threshold makes the system less sensitive to small noise and interferences, thereby enhancing stability and accuracy.

By introducing ABZ incremental output hysteresis, errors can be reduced, and the system's immunity to interference can be improved. This is particularly important for applications that require high precision and stability, especially in noisy environments or in the presence of interferences. By introducing ABZ incremental output hysteresis, errors can be reduced, and the system's immunity to interference can be improved. This is particularly important for applications that require high precision and stability, especially in noisy environments or in the presence of interferences.

## 8 PWM Absolute Position Output

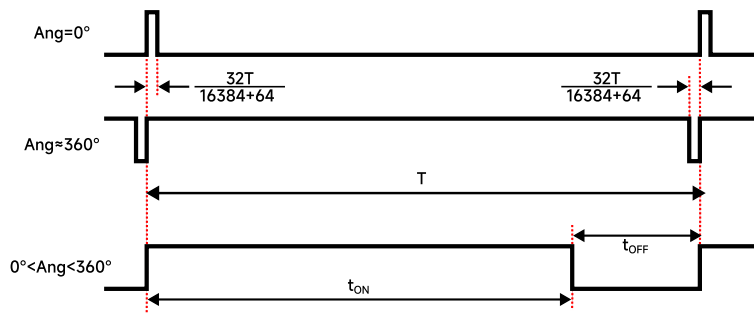
The KTH7801 provides a single-line 14-bit absolute value PWM output mode, as shown in Figure 14. The PWM output is the default output form of pin 9.

The logic signal of the PWM output is directly proportional to the magnetic angle, with a PWM frequency of 972 Hz. An angle of 0° corresponds to a duty cycle of  $32 / (16384 + 64)$ , and an angle of 360° corresponds to a duty cycle of  $(16384 + 32) / (16384 + 64)$ . The resolution is 14 bits. The angle corresponding to any duty cycle can be calculated using Equation 2.

$$Ang = \frac{360}{16384} \left[ \frac{(16384 + 64) \cdot t_{ON}}{t_{ON} + t_{OFF}} - 32 \right] \quad (2)$$

where  $Ang$  is the angle in degrees,  $t_{ON}$  is the ON time of the PWM signal, and  $t_{OFF}$  is the OFF time of the PWM signal.

**Figure 14: PWM Timing**

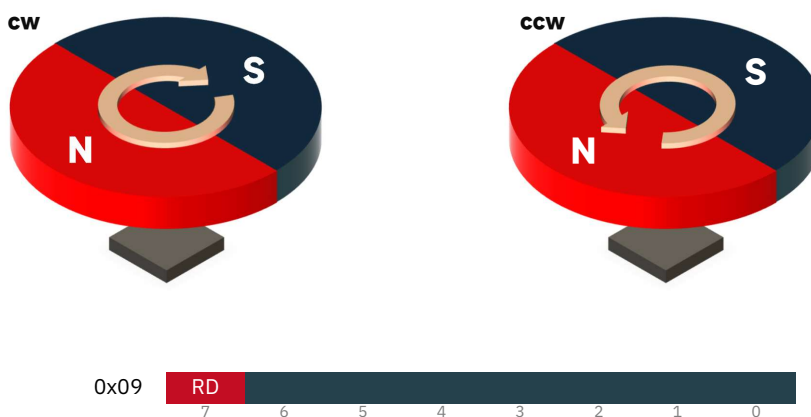


## 9 System Operation Settings

### 9.1 Rotation Direction

The RD register defines the relationship between the output angle increment and the rotation direction. By default, RD=1, when the magnet (viewed from above) rotates clockwise (CW) when viewed from above, the output angle of the chip increases.

**Figure 15: Rotation Direction**



### 9.2 Zero Point Setting

The register **Z(15:0)** defines the zero position, and this value applies to all types of angle outputs. The sensor's zero position can be programmed with 16-bit resolution.

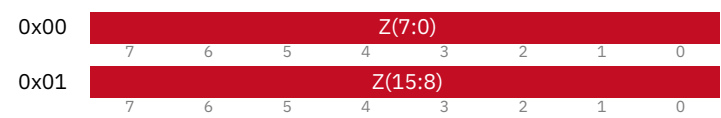
When RD (rotation direction) is set to 1, the output angle of the sensor can be calculated using the following formula, where the 16-bit binary number is the value currently read by SPI, and the desired angle is the angle (0-360°) that the user expects after changing the Z(15:0) register:

$$Z = \text{NOT} \left( 16\text{-bit binary value} - \left( \frac{\text{Desired Angle}}{360} \right) \times 2^{16} \right) + 1 \quad (3)$$

When RD (rotation direction) is set to 0, the output angle of the sensor can be calculated using the following formula, where the 16-bit binary number is the value currently read by SPI, and the desired angle is the angle (0-360°) that the user expects after changing the Z(15:0) register:

$$Z = 16\text{-bit binary value} - \left( \frac{\text{Desired Angle}}{360} \right) \times 2^{16} \quad (4)$$

For example, when RD (rotation direction) is set to 1 and the 16-bit binary value is 16384 (i.e., SPI output angle is 90 degrees), setting Z(15:0) to the complement of 16384 (bitwise NOT plus 1), which is 49152, results in an output value of 0 (output angle of 0 degrees). When RD (rotation direction) is set to 0 and the 16-bit binary value is 16384 (i.e., SPI output angle is 90 degrees), setting Z(15:0) to 16384 results in an output value of 0 (output angle of 0 degrees).



9.3 Threshold Detection Settings

To facilitate user applications, the KTH7801 series allows for the configuration of both low threshold magnetic field alarms (mgl) and high threshold magnetic field alarms (mgh). For example, when mgh(2:0) is set to 1, if the magnetic field exceeds 34mT, the MGH pin will be pulled high. When the magnetic field decreases below 28mT, the MGH pin will be pulled low. Similarly, when mgl(2:0) is set to 0, if the magnetic field falls below 18mT, the MGL pin will be pulled high, and when the magnetic field increases above 24mT, the MGL pin will be pulled low.

The threshold detection settings are configured using the following register:



The values of mgh(2:0) and mgl(2:0) correspond to specific magnetic field thresholds and pin behavior. The table below illustrates the corresponding magnetic field intensities for each threshold configuration:

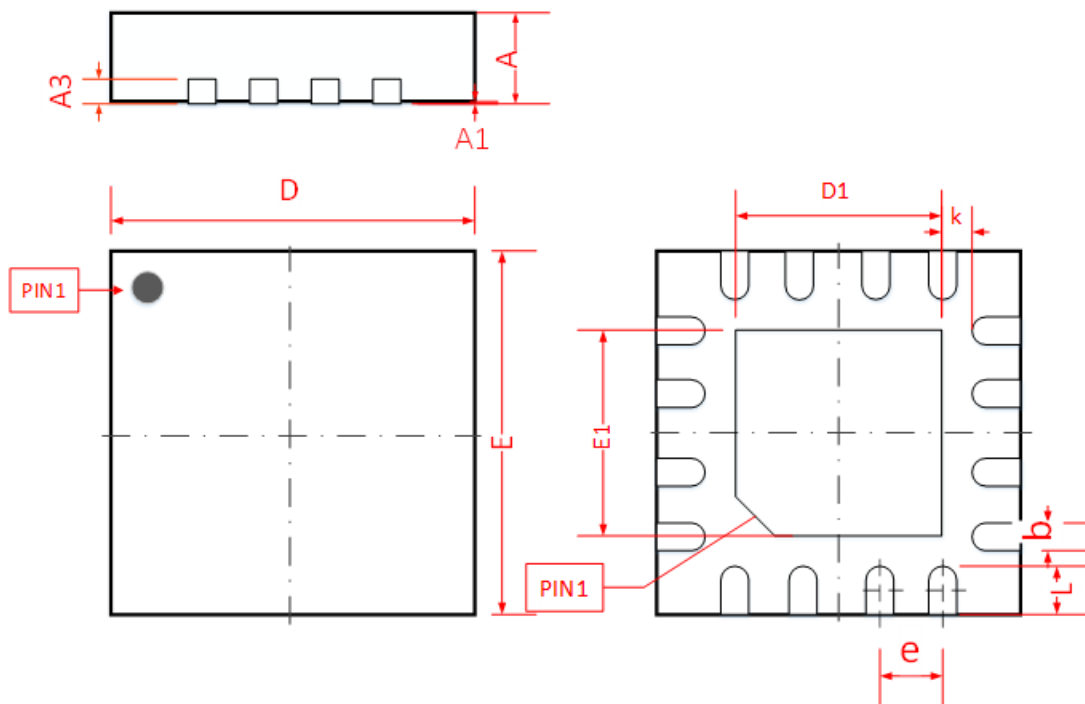


**Table 12: Magnetic Field Intensity Corresponding to High and Low Threshold Alarms**

| <b>mgh(2:0)</b> | <b>MGH Rising</b> | <b>MGH Falling</b> | <b>mgl(2:0)</b> | <b>MGL Rising</b> | <b>MGL Falling</b> |
|-----------------|-------------------|--------------------|-----------------|-------------------|--------------------|
| 0               | 23mT              | 16mT               | 0               | 18mT              | 24mT               |
| 1               | 34mT              | 28mT               | 1               | 30mT              | 36mT               |
| 2               | 47mT              | 40m                | 2               | 42mT              | 48mT               |
| 3               | 58mT              | 52mT               | 3               | 54mT              | 60mT               |
| 4               | 70mT              | 63mT               | 4               | 65mT              | 71mT               |
| 5               | 81mT              | 75mT               | 5               | 77mT              | 83mT               |
| 6               | 92mT              | 86mT               | 6               | 88mT              | 94mT               |
| 7               | 103mT             | 97mT               | 7               | 99mT              | 105mT              |

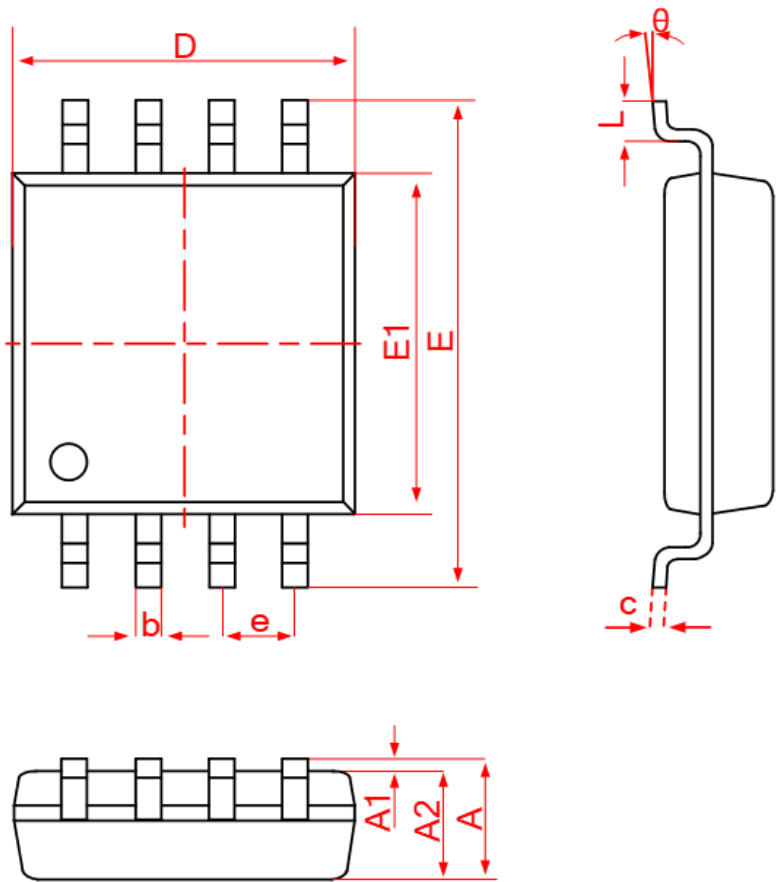
## 10 Packaging

The KTH7801 sensor is available in a specific package to ensure proper protection and compatibility with various applications. The packaging information is provided in Figure 16 and Figure 17.



| Symbol | Dimensions in Millimeters |       |
|--------|---------------------------|-------|
|        | Min                       | Max   |
| A      | 0.700                     | 0.800 |
| A1     | 0.000                     | 0.050 |
| A3     | 0.203REF.                 |       |
| D      | 2.900                     | 3.100 |
| E      | 2.900                     | 3.100 |
| D1     | 1.350                     | 1.550 |
| E1     | 1.350                     | 1.550 |
| k      | 0.375REF.                 |       |
| b      | 0.200                     | 0.300 |
| e      | 0.500BSC.                 |       |
| l      | 0.300                     | 0.500 |

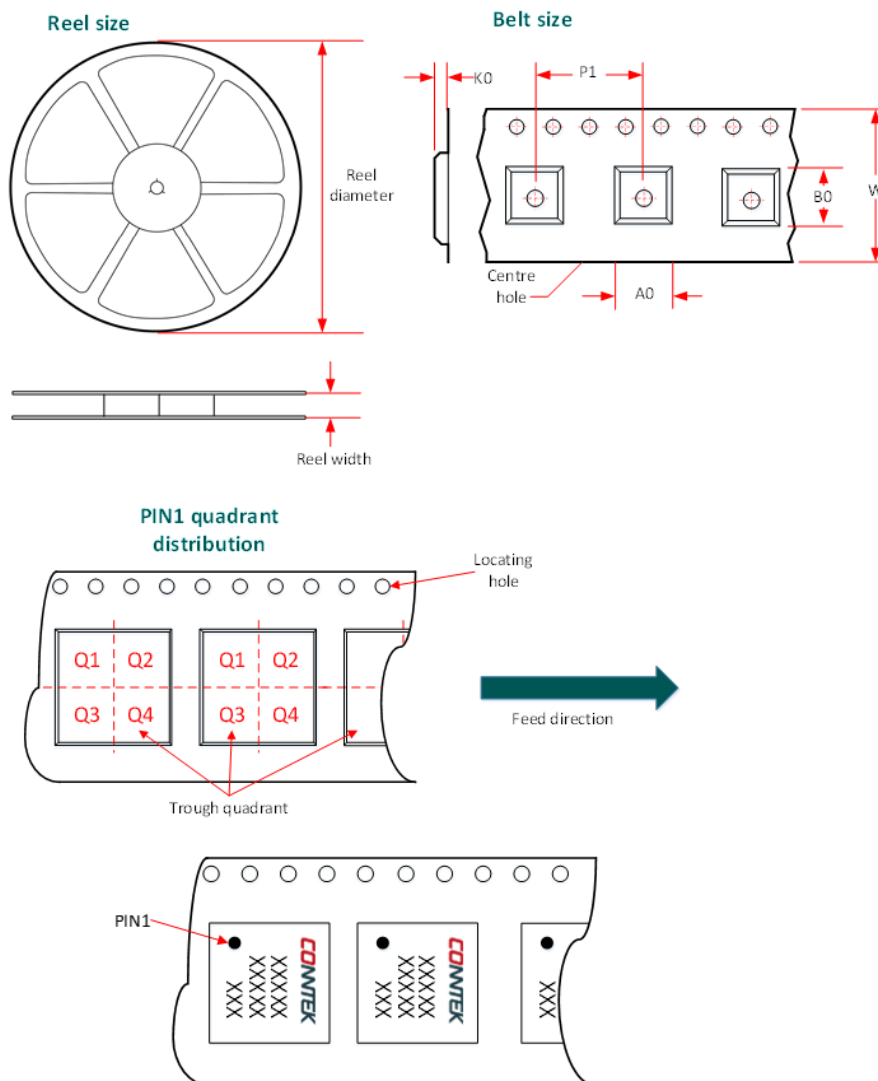
Figure 16: QFN-16L Packaging Information for KTH7801



| Symbol   | Dimensions in Millimeters |       | Dimensions in Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min                       | Max   | Min                  | Max   |
| A        | 1.35                      | 1.75  | 0.53                 | 0.069 |
| A1       | 0.100                     | 0.250 | 0.004                | 0.010 |
| A2       | 1.35                      | 1.550 | 0.053                | 0.061 |
| b        | 0.330                     | 0.510 | 0.013                | 0.020 |
| c        | 0.170                     | 0.250 | 0.006                | 0.010 |
| D        | 4.700                     | 5.100 | 0.185                | 0.200 |
| E        | 5.800                     | 6.200 | 0.228                | 0.244 |
| E1       | 3.800                     | 4.000 | 0.150                | 0.157 |
| e        | 1.270 TYP.                |       | 0.050 TYP.           |       |
| L        | 0.400                     | 0.800 | 0.016                | 0.031 |
| $\theta$ | 0°                        | 8°    | 0°                   | 8°    |

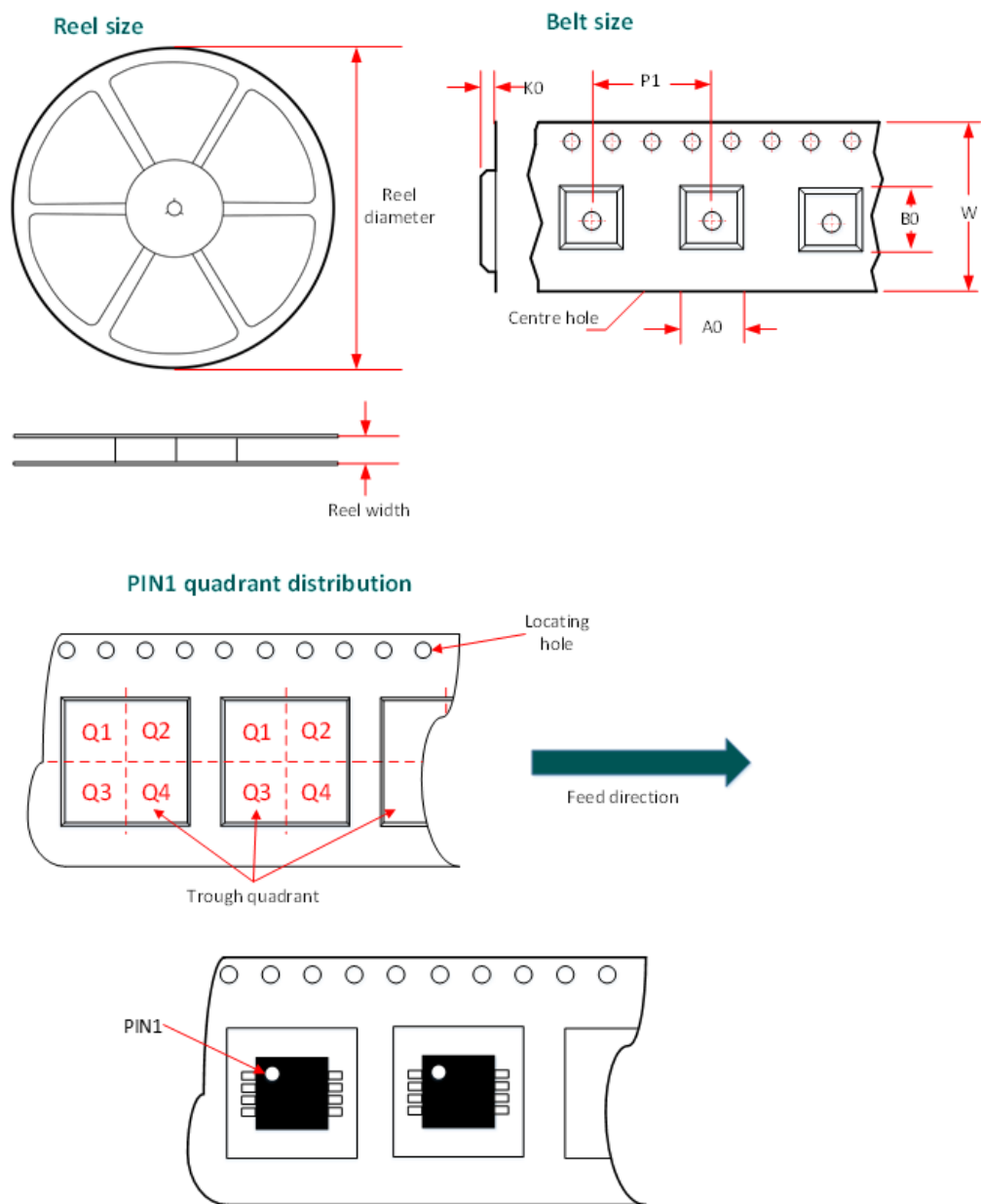
Figure 17: SOP-8 Packaging Information for KTH7801

# 11 Tape and Reel Information



| Package Type | Pin s | SPQ  | Reel diameter | Reel width | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 方向 |
|--------------|-------|------|---------------|------------|---------|---------|---------|---------|--------|---------|
| QFN3*3-16L   | 16    | 5000 | 330           | 12.4       | 3.35    | 3.35    | 1.13    | 8.00    | 12.00  | Q1      |

Figure 18: QFN-16L Tape and Reel Information for KTH7801



| Package Type | Pin s | SPQ  | Reel diameter | Reel width | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 方向 |
|--------------|-------|------|---------------|------------|---------|---------|---------|---------|--------|---------|
| SOP8         | 8     | 4000 | 330           | 13         | 6.60    | 5.3     | 2.1     | 8.00    | 12.00  | Q1      |

Figure 19: SOP-8 Tape and Reel Information for KTH7801

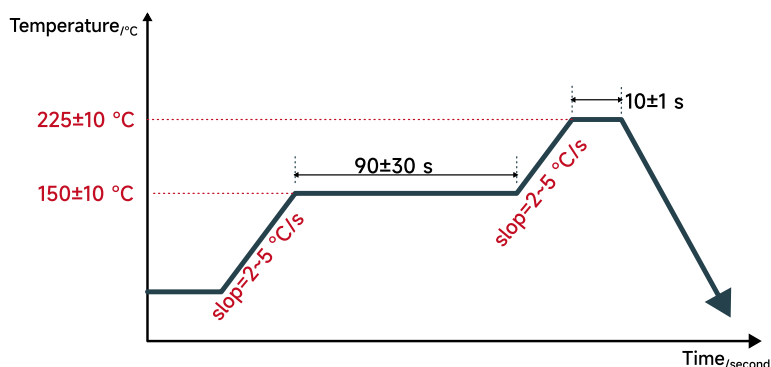


Figure 20: Soldering Temperature Profile for KTH7801

## 12 Selection Guide

Table 13: Model List

| Model   | Noise (1 sigma) | Output Interface   | Time Constant $\tau$ (ms) | Operating Magnetic Field | Application Scenario |
|---------|-----------------|--------------------|---------------------------|--------------------------|----------------------|
| KTH7801 | 0.015°          | SPI, SSI, PWM, ABZ | 0.51                      | 30-150mT                 | Automotive           |
| KTH7802 | 0.015°          | SPI, ABZ, UVW      | 0.51                      | 30-150mT                 | Automotive           |
| KTH7803 | 0.004°          | SPI, SSI, PWM, ABZ | 16.3                      | 30-150mT                 | Automotive           |

## 13 Ordering Information

Table 14: Ordering Information

| Model            | Package Type | Operating Temperature | Application Scenario | Pin Count | CRC Check Available |
|------------------|--------------|-----------------------|----------------------|-----------|---------------------|
| KTH7801-X-N-QN16 | QFN3x3-16L   | -40°C to 125°C        | Automotive           | 16        | No                  |
| KTH7801-X-N-SOP8 | SOP-8        | -40°C to 125°C        | Automotive           | 8         | No                  |
| KTH7801-X-C-QN16 | QFN3x3-16L   | -40°C to 125°C        | Automotive           | 16        | Yes                 |
| KTH7801-X-C-SOP8 | SOP-8        | -40°C to 125°C        | Automotive           | 8         | Yes                 |
| KTH7803-X-N-QN16 | QFN3x3-16L   | -40°C to 125°C        | Automotive           | 16        | No                  |

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